

AP9476GM-HF-VB Datasheet N-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^d | Q _g (Typ.) | | | |
| 60 | 0.012 at V _{GS} = 10 V | 12 | 10.5 nC | | | |
| 00 | 0.015 at V _{GS} = 4.5 V | 11 | 10.5110 | | | |

FEATURES

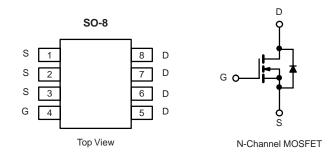
- Halogen-free According to IEC 61249-2-21 Definition
- Pb-free

- Trench Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R_g and UIS Tested





· CCFL Inverter



| Parameter | Symbol | Limit | Unit | | |
|---|-----------------------------------|-----------------|---------------------|----|--|
| Drain-Source Voltage | V _{DS} | 60 | V | | |
| Gate-Source Voltage | | V_{GS} | ± 20 | v | |
| | T _C = 25 °C | | 12 ^a | | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | | 11 | | |
| Continuous Diain Current (1) = 150 °C) | T _A = 25 °C | l _D | 8.0 ^{b, c} | | |
| | T _A = 70 °C | | 7.6 ^{b, c} | | |
| Pulsed Drain Current | I _{DM} | 25 | A | | |
| Continuous Source Drain Diada Current | T _C = 25 °C | I- | 4.2 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | ls — | 2.1 ^{b, c} | | |
| Avalanche Current | 1 04 | I _{AS} | 15 | | |
| Single-Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 11.2 | mJ | |
| | T _C = 25 °C | | 5 | | |
| Mayimum Dayar Dissination | T _C = 70 °C | P _D | 3.2 | W | |
| Maximum Power Dissipation | T _A = 25 °C | | 2.5 ^{b, c} | vv | |
| | T _A = 70 °C | | 1.6 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|------|------|--|
| Parameter | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 10 s | R _{thJA} | 38 | 50 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 20 | 25 | C/VV | |

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|---|-------|-------|-------|--------|--|
| Static | | | | • | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | | | 55 | | m\//0C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | $I_D = 250 \mu\text{A}$ | | - 6.3 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1.0 | | 3.0 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zoro Coto Voltago Drain Current | lana | V _{DS} = 60 V, V _{GS} = 0 V | | | 1 ,,, | | |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 25 | | | Α | |
| | В | V _{GS} = 10 V, I _D = 4.6 A | 0.012 | | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$ | | 0.015 | | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 4.6 A | | 20 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 1100 | | pF | |
| Output Capacitance | C _{oss} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 90 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 55 | | | |
| Tatal Cata Channa | Q _g | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$ | | 21 | 32 | nC | |
| Total Gate Charge | | | | 10.5 | 16 | | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$ | | 3.5 | | | |
| Gate-Drain Charge | Q _{gd} | | | 4.2 | | | |
| Gate Resistance | R _g | f = 1 MHz | | 3.3 | 5 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 20 | 30 | | |
| Rise Time | t _r | $V_{DD} = 30 \text{ V}, R_{L} = 5.4 \Omega$ | | 150 | 225 | 1 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 5.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | | 20 | 30 | | |
| Fall Time | t _f | | | 60 | 90 | | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | ns | |
| Rise Time | ì, ´ | $V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$ | | 15 | 25 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong 5.6 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 25 | 40 | | |
| Fall Time | ì, | | | 10 | 15 | | |
| Drain-Source Body Diode Characterist | ics | | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 4.2 | ^ | |
| Pulse Diode Forward Current ^a | I _{SM} | - | | | 25 | Α | |
| Body Diode Voltage | V _{SD} | I _S = 2 A | | 0.8 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | - | | 25 | 50 | ns | |
| Body Diode Reverse Recovery Charge | | | | 25 | 50 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = 5.5 \text{ A}, \text{ di/dt} = 100 \text{ A/µs}, I_J = 25 \text{ C}$ | | 19 | | ns | |
| Reverse Recovery Rise Time | t _b | | | 6 | | | |

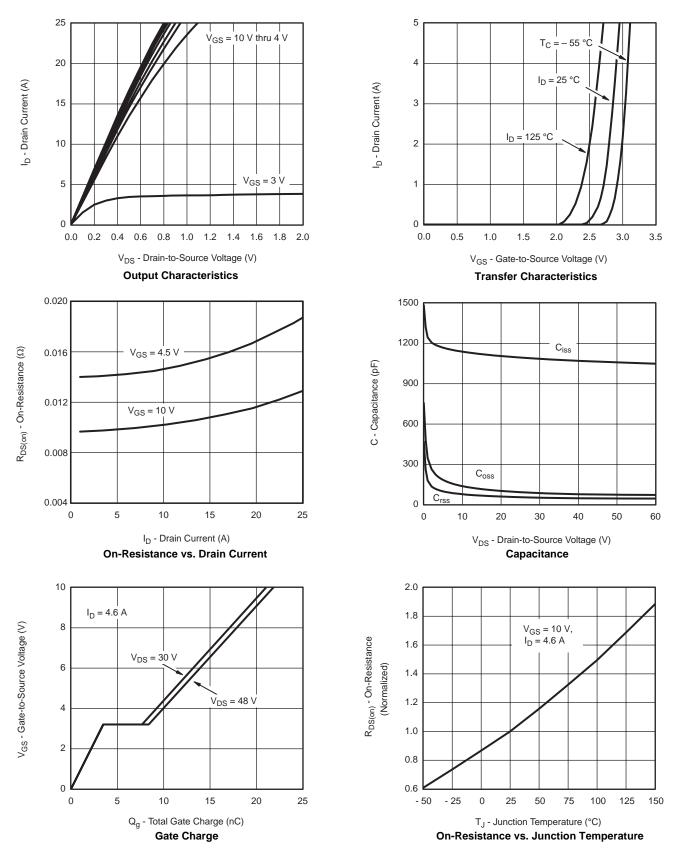
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

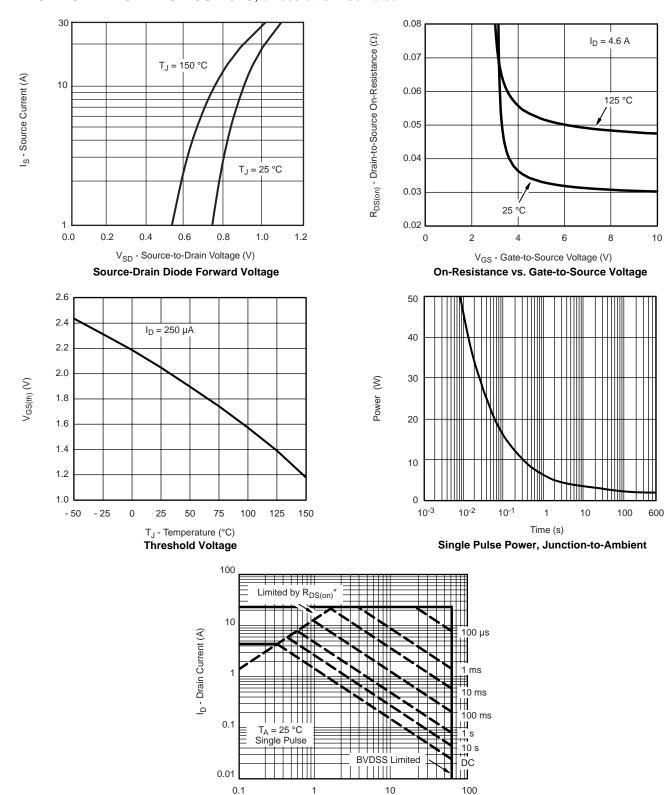
a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.





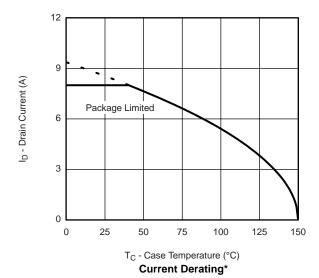


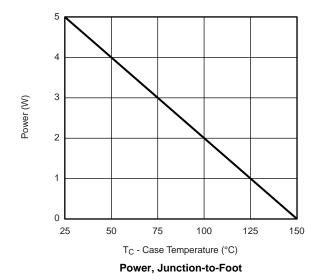


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$$\begin{split} & \text{V_{DS} - Drain-to-Source Voltage (V)$} \\ ^* \text{$V_{GS}$ > minimum V_{GS} at which $R_{DS(on)}$ is specified} \\ & \textbf{Safe Operating Area} \end{split}$$

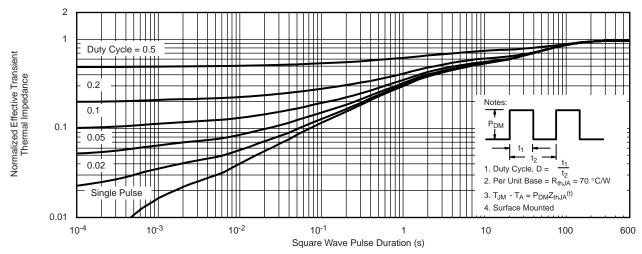




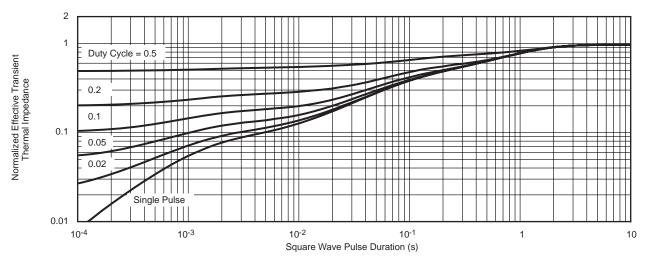


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

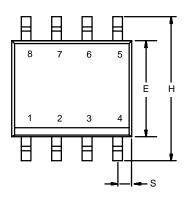


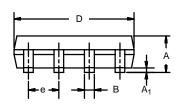
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







| | MILLIM | IETERS | INC | HES | | |
|------------------------------|----------|--------|-----------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| А | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 BSC | | 0.050 BSC | | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Pay I 11-San-06 | | | | | | |

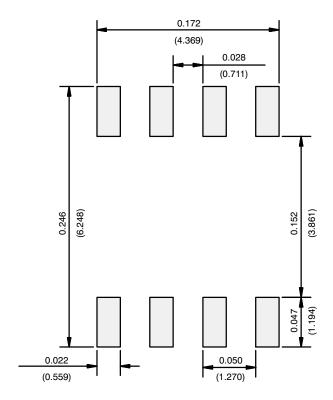
ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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